

PQ1CX12H2ZPQ

Bootstrap system
Chopper Regulator

Features

- 1.Maximum switching current: 2.5A
- 2.High efficiency(efficiency : 88%[$V_{IN}=5V, V_{OUT}=3.3V$])
- 3.Built-in oscillation circuit
(Oscillation frequency:TYP.150kHz)
- 4.Built-in overheat, overcurrent protection functions
- 5.Variable output voltage
(Output variable range: V_{ref} to 24V)
- 6.RoHS directive compliant

Applications

- 1.AV equipment
- 2.Digital OA equipment

Absolute Maximum Ratings

($T_a=25^{\circ}C$)

Parameter	Symbol	Rating	Unit
*1 Input voltage	V_{IN}	33	V
*2 Boost terminal voltage	V_B	33	V
*3 Voltage between V_B and V_{IN}	V_{B-I}	15	V
Malfunction input voltage	V_{adj}	7	V
Input-output voltage	V_{I-O}	34	V
*4 Output-GND voltage	V_{OUT}	-1	V
*5 ON/OFF control voltage	V_C	-0.3 to 20	V
Switching current	I_{SW}	2.5	A
*6 Power dissipation	P_D	0.9	W
*7 Junction temperature	T_j	150	$^{\circ}C$
Operating temperature	T_{opr}	-30 to +85	$^{\circ}C$
Storage temperature	T_{stg}	-40 to +150	$^{\circ}C$
Soldering temperature	T_{sol}	260(for 10s)	$^{\circ}C$

*1 Voltage between V_{IN} and GND

*2 Voltage between V_B and GND

*3 Voltage between V_B and V_{IN}

*4 Voltage between V_{OUT} and GND

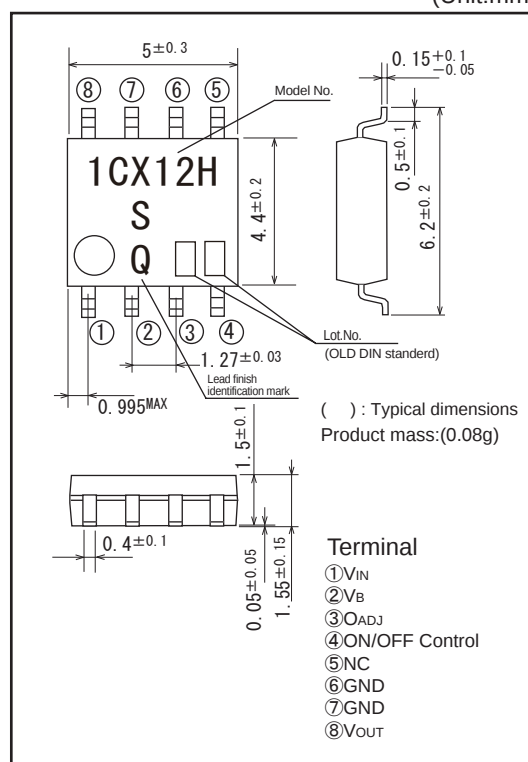
*5 Voltage between ON/OFF and GND

*6 At the time of the PCB mounting

*7 There is case that over heat protection function operates at the temperature $T_j=125^{\circ}C$ to $150^{\circ}C$, so this item cannot be used in this temperature range.

Outline Dimensions

(Unit:mm)



Lead finish:Lead-free solder plating
(Composition: Sn2Bi)

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Electrical Characteristics

(VIN=5 V, Io=0.5 A, Vo=3.3V, Terminal No. 4 open and Ta=25°C unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Voltage ratio VOUT-VIN	DI-O	-	15	-	-	%
Output saturation voltage	Vsat	Isw=2.0A	-	0.25	0.4	V
Reference voltage	VREF	-	1.235	1.26	1.285	V
Load regulation	RegL	Io=0.5 to 2.0A	-	0.2	1.5	%
Line regulation	RegI	VIN=5 to 20V	-	1	2.5	%
Efficiency	η	Io=2.0 A	-	88	-	%
Oscillation frequency	fo	-	135	150	165	kHz
Overcurrent detection level	IL	Switching current peak	2.55	3.2	4.2	A
Maximum Duty	DMAX	Terminal 3 = 1.1 V	83	90	-	%
Charge current	ICHG	Terminal 3,8:OPEN, Terminal 4	-	-10	-	μ A
Input threshold voltage	VTHL	Duty=0 %,Terminal 3=0V,Terminal 4	-	1.3	-	V
	VTHH	Duty=DMAX,Terminal 3:OPEN,Terminal 4	-	2.3	-	V
ON threshold voltage	VTHON	Terminal 3 = 0V,Terminal 4	0.7	0.8	0.9	V
Standby current	ISD	VIN=33V,Terminal 4 = 0V	-	120	400	μ A
Output OFF-state consumption current	IQS	VIN=33V,Terminal 4 = 0.9V	-	5	10	mA
Minimum Input Voltage	VIN(MIN)	-	-	-	4.5	V
Minimum Boost Voltage	VBOOST(MIN)	VB-VOUT Voltage	-	-	3	V

Fig.1 Test Circuit

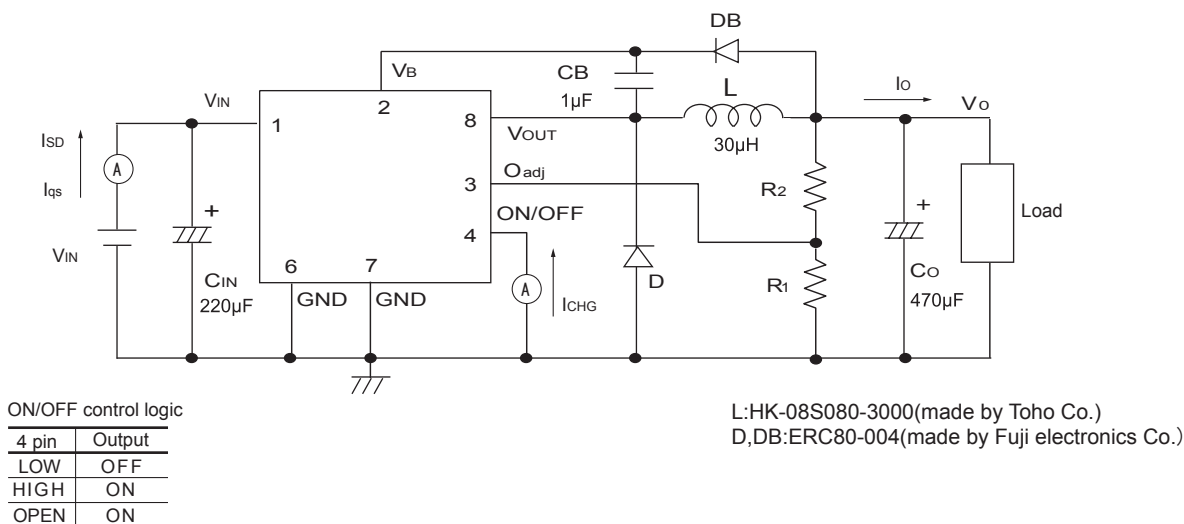
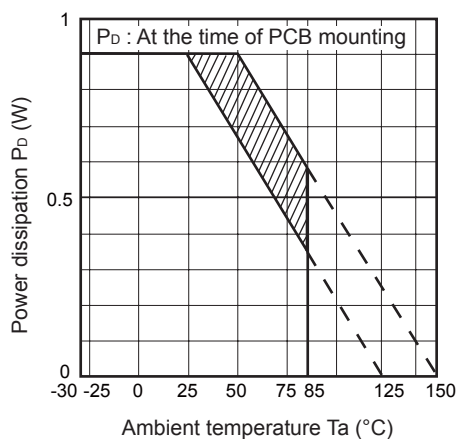


Fig.2 Power Dissipation vs.Ambient Temperature



Note)Oblique line portion:Overheat protection may operate in this area

Fig.3 Overcurrent Protection Characteristics (Typical Value)

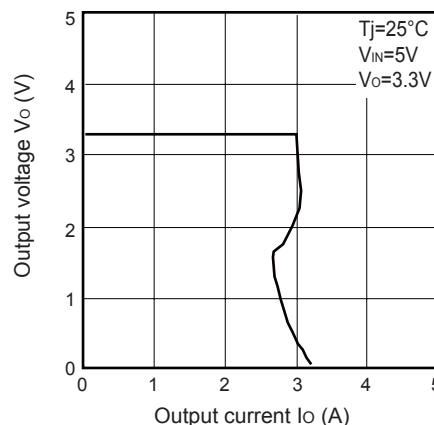


Fig.4 Efficiency vs. Input Voltage

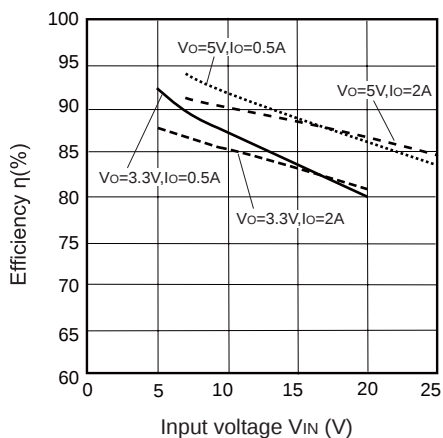


Fig.5 Output Saturation Voltage vs. Switching Current

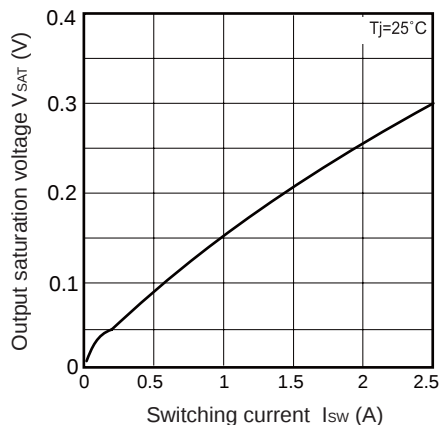


Fig.6 Stand-by Current vs. Input Voltage

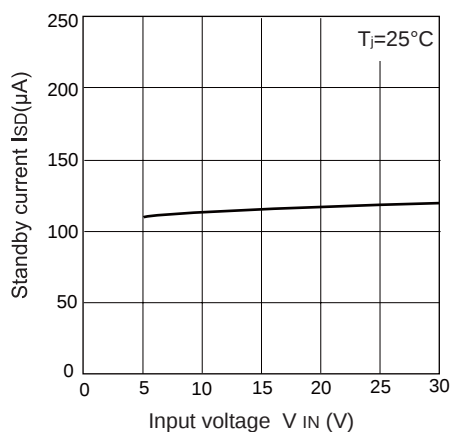


Fig.7 Reference Voltage Fluctuation vs. Junction Temperature

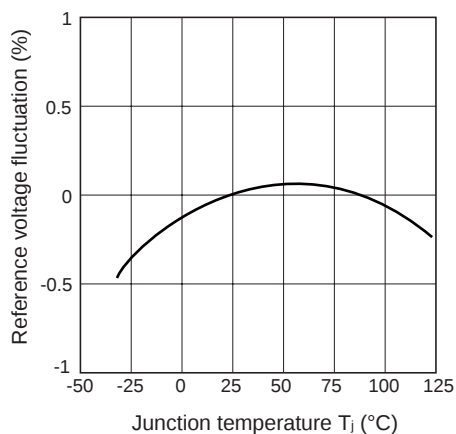


Fig.8 Load Regulation vs. Output Current

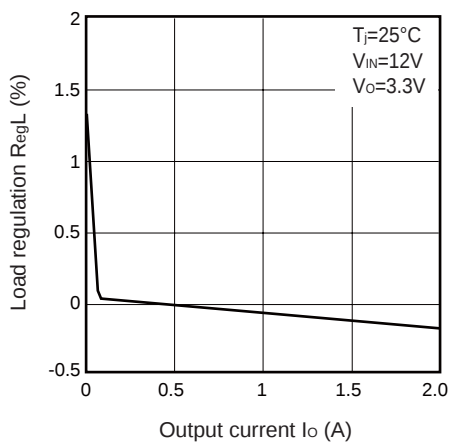


Fig.9 Line Regulation vs. Input Voltage

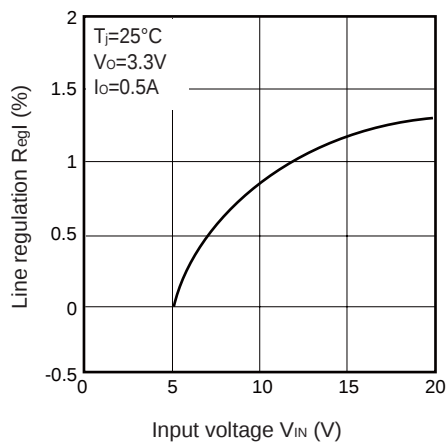


Fig.10 Oscillation Frequency Fluctuation vs. Junction Temperature

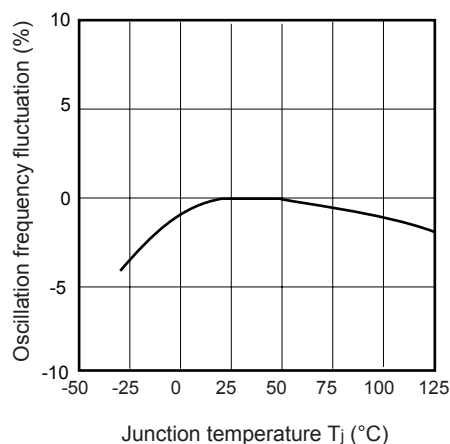


Fig.11 Overcurrent Detecting Level Fluctuation vs. Junction Temperature

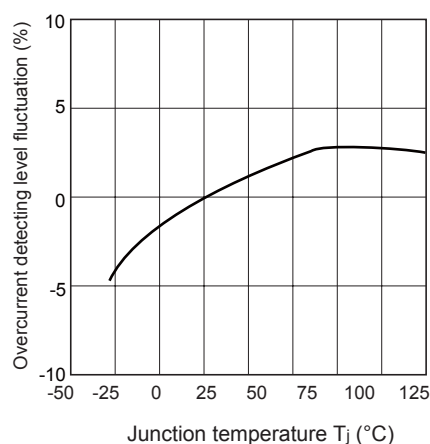


Fig.12 Threshold Voltage vs. Junction Temperature

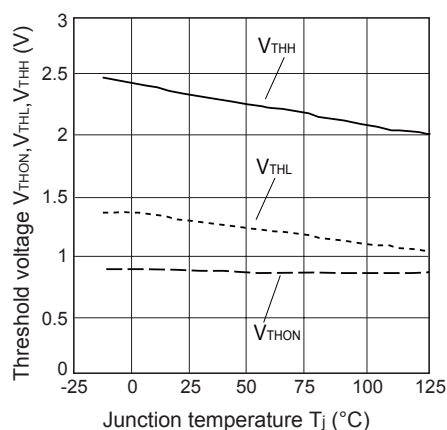


Fig.13 Operating Dissipation Current vs. Input Voltage

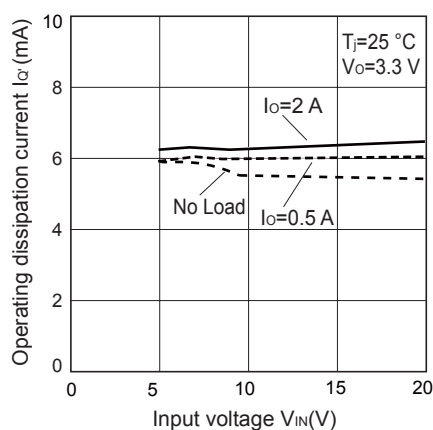
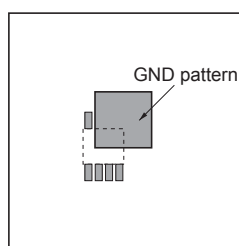
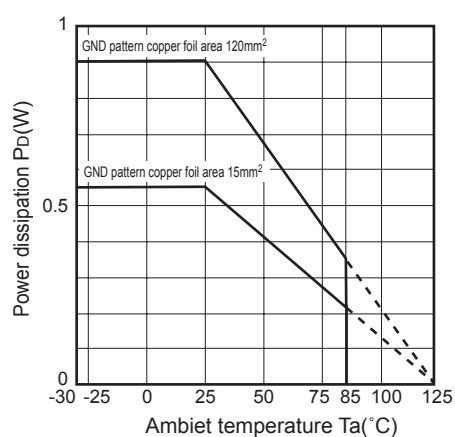


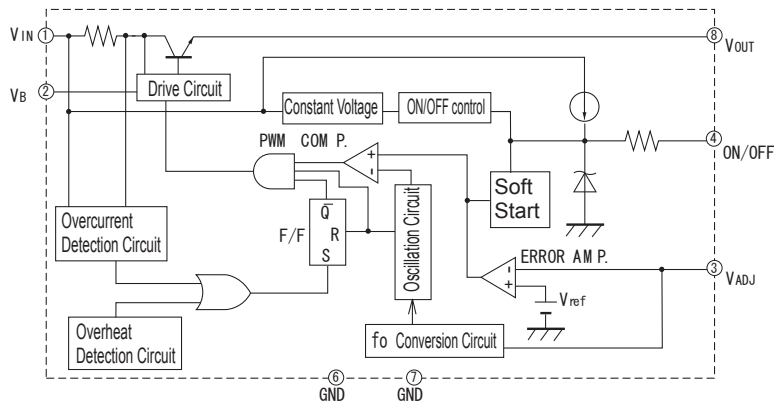
Fig.14 PD-Ta rating(Typical value)



Mounting PCB

Material : Glass-cloth epoxy resin
 Size : 30mm × 30mm × 1mm
 GND pattern copper foil area : 120mm², 35μm

■ Block Diagram



■ Step-down voltage output circuit diagram

